

FEATURES

- DOSA – Standard Form, Fit & Function
- Industry standard 1/16th brick footprint
- 4:1 input voltage range: 9- 36 or 18 – 75Vin
- No minimum load required
- -40 °C to +123°C operation
- Withstands 100 V input transients
- Fixed-frequency operation
- Full protection for OTP, OCP, OVP, UVLO and auto-restart
- Remote ON/OFF - positive or negative and Remote sense
- Output voltage trim range: $\pm 10\%$
- On-board input differential LC filter
- ROHS II Directive 2011/65/EU Compliant
- Designed to meet UL94, V-0 flammability rating
- Compliant to REACH (EC) No 1907/2006
- Designed to meet UL/CSA60950-1, TUV per IEC/EN60950-1, 2nd edition (pending)
- Designed to meet Class B conducted emissions per EN55022

PRODUCT OVERVIEW

This SB series of DC-DC converters is an open frame sixteenth-brick DC-DC converter that conforms to industry standard specifications. These converters operate over the wide input voltage range of 9 to 36 or 18 to 75 VDC and provide tightly regulated output voltages. The high efficiency of this SB series allows operation over a wide ambient temperature range of -40°C to $+123^{\circ}\text{C}$ with minimal derating. All standard models come with 2,250 Volts of DC isolation, while option I model offers much higher isolation of 2,828 volts. The standard feature set includes remote On/Off (positive or negative enable), input under-voltage lockout, output overvoltage protection, overcurrent and short circuit protection, output voltage trim, remote sense and over-temperature shutdown with hysteresis.

APPLICATIONS:

- Distributed Power Architectures
- Instrumentation
- Data and Wireless Communications
- Servers
- “Bus” Converter Applications

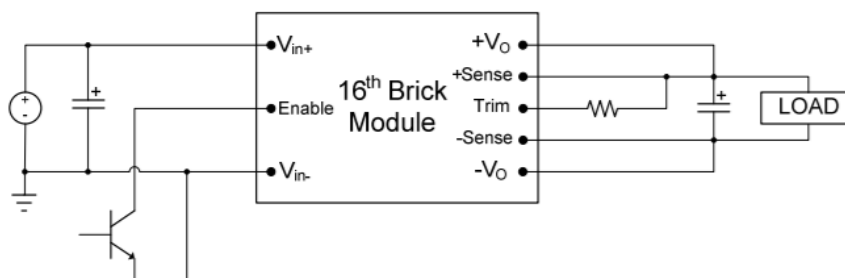
AVAILABLE OPTIONS

- Customizable Input / Output voltages
- SMT or Thru-Hole Mounting
- Higher Power
- Optional Baseplate

Contact DATEL for other series of 1/16th - Brick footprint, optimized for Cost Savings or higher performance

MODEL NUMBER	INPUT VOLTAGE	OUTPUT VOLTAGE	OUTPUT CURRENT MAX	EFFICIENCY %	LOAD REGULATION	OPTIONS
SB22S3.3-15	9 – 36 VDC	3.3 VDC	15 A	89	$\pm 0.1\%$	B, S, N, P, I
SB22S5-8	9 – 36 VDC	5 VDC	8 A	88	$\pm 0.1\%$	B, S, N, P, I
SB45S3.3-15	18 – 72 VDC	3.3 VDC	15 A	89	$\pm 0.1\%$	B, S, N, P, I
SB45S5-10	18 – 72 VDC	5 VDC	10 A	89	$\pm 0.1\%$	B, S, N, P, I
SB45S5-8	18 – 75 VDC	5 VDC	8 A	87	$\pm 0.1\%$	B, S, N, P, I
SB45S12-4.2	18 – 72 VDC	12 VDC	4.2 A	89	$\pm 0.1\%$	B, S, N, P, I
SB45S15-3	18 – 72 VDC	15 VDC	3 A	89	$\pm 0.1\%$	B, S, N, P, I

CONNECTION DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameters	Conditions	Model	Min.	Typical	Max.	Units
Input Voltage						
Continuous	DC	24V _{in}	0		36	Volts
		SB45S5-8	0		75	
		Others	0		72	
Operating Ambient Temperature	With Derating	All	-40		+123	°C
Storage Temperature		All	-55		+125	°C

Stresses above the absolute maximum ratings can cause permanent damage to the device.

ELECTRICAL SPECIFICATIONS

Note: All specifications are typical at nominal input, full load at 25°C, Airflow=300 LFM, V_{in} = Nominal, C_{in}=33 μ F, unless otherwise noted

INPUT CHARACTERISTICS

Parameters	Conditions	Model	Min.	Typical	Max.	Units
Operating Input Voltage		24V _{in}	9	24	36	Volts
		SB45S5-8	18	48	75	
		Others	36	48	72	
Input Under Voltage Lockout						
Turn-On Voltage Threshold		24V _{in}	9,2	9.6	10	Volts
		48V _{in}	17.2	17.6	18	
Turn-Off Voltage Threshold		24V _{in}	8.1	8.5	8.9	Volts
		48V _{in}	15.8	16.2	16.6	
Input Voltage Transient	100 ms	24V _{in} 48V _{in}		50 100		Volts
Maximum Input Current	100% Load, V _{in} =9V	24V _{in}			6200	mA
	100% Load, V _{in} =18V	48V _{in}			3300	
No-Load Input Current	V _{in} =Nominal input	SB22S3.3-15 SB22S5-8 SB45S3.3-15 SB45S5-10 SB45S5-8 SB45S12-4.2 SB45S15-3		100 40 40 50 50 40 40	120 80 60 100 100 60 60	mA
Off Converter Input Current	Shutdown input idle current	All		2	5	mA
Inrush Current (I ² t)	As per ETS300 132-2	All			0.01	A ² s
Input Voltage Ripple Rejection	120Hz	ALL		50		dB
Input Reflected-Ripple Current	5Hz to 50MHz	All		10	30	mAPK-PK

OUTPUT CHARACTERISTIC

Parameters	Conditions	Model	Min.	Typical	Max.	Units
Output Voltage Set Point	V_{in} =Nominal V_{in} , $I_o = I_{o_max}$, $T_c=25^{\circ}C$	$V_o=3.3$ $V_o=5.0$ $V_o=12$ $V_o=15$	3.25 4.925 11.82 14.78	3.3 5 12 15	3.35 5.075 12.18 15.22	Volts
Output Voltage Regulation						
Line Regulation	V_{in} =High line to Low line Full Load	All			± 0.1	%
Load Regulation	$I_o =$ Full Load to min. Load	All			± 0.1	%
Temperature Coefficient	$TC=-40^{\circ}C$ to $+100^{\circ}C$				± 0.03	%/ $^{\circ}C$
Output Voltage Ripple and Noise	5Hz to 20MHz bandwidth					
Peak-to-Peak	Full Load, 20MHz bandwidth 10uF tantalum and 1uF ceramic capacitor	SB22S3.3-15			80	mV
		SB22S5-8			80	
		SB45S3.3-15			80	
		SB45S5-10			150	
		SB45S5-8			100	
	SB45S12-4.2	150			150	
	SB45S15-3	150				
Operating Output Current Range		SB22S3.3-15	0		15000	mA
		SB22S5-8	0		8000	
		SB45S3.3-15	0		15000	
		S45S5-10	0		10000	
		SB45S5-8	0		8000	
		SB45S12-4.2	0		4200	
		SB45S15-3	0		3000	
Peak Short-Circuit Current		SB22S3.3-15			25	A
		SB22S5-8			20	
		SB45S3.3-15			30	
		S45S5-10			28	
		SB45S5-8			28	
		SB45S12-4.2			20	
		SB45S15-3			8	
Output DC Current-Limit Inception	Output Voltage=90% $V_{0, nominal}$		110	140	170	%
Maximum Output Capacitance	Full load, Resistance	SB22S3.3-15			10000	μF
		SB22S5-8			4700	
		SB45S3.3-15			10000	
		S45S5-10			4700	
		SB45S5-8			4700	
		SB45S12-4.2			2200	
		SB45S15-3			1000	

FEATURE CHARACTERISTICS

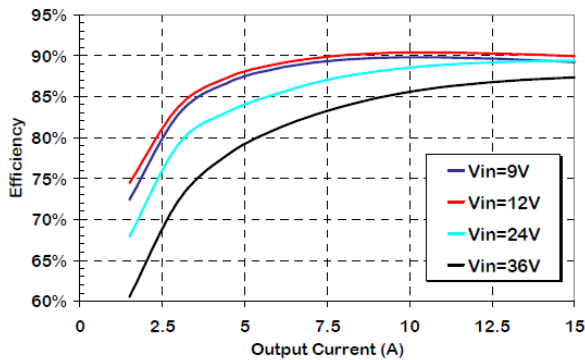
Parameter	Conditions	Model	Min	Typ	Max	Unit
Switching Frequency		SB22S3.3-15 SB22S5-8 SB45S3.3-15 S45S5-10 SB45S5-8 SB45S12-4.2 SB45S15-3		480 430 480 440 430 510 480		kHz
Output Voltage Trim Range ¹		Vo=12, 15 Others	-20 -10		+10 +10	%
Remote Sense Compensation ¹		All			+10	%
Output Over-voltage Protection	Non-latching	All	115	120	140	%
Over-temperature Protection	Average PCB temp, non-latching	SB45S5-8 Others		125 135		°C
Peak Back-drive Output Current during startup into pre-biased output	C _{OUT} =220μF, aluminum Sinking current from external voltage source equal to V _{OUT} – 0.6V and connected to the output via 1Ω resistor.	SB45S15-3 Others		500 400	800 500	mA
Back-drive Output Current in OFF state	Converter disabled			0	5	mA
Enable to Output Turn-on Time	V _{OUT} = 0.9*V _{OUT_NOM}			20		ms
Output Enable ON/OFF Negative Enable Converter ON Converter OFF Positive Enable Converter ON	All voltages are WRT – Vin. Converter has internal pull-up of approx. 5V		-0.5 2.4 2.4 -0.5	 0.25	0.8 20 20 0.8 1	VDC VDC VDC VDC mA
Output Voltage Overshoot @ startup				0	2	%Vo
Auto-Restart Period	With all protection features			100		ms
Efficiency Full Load		SB22S3.3-15 SB22S5-8 SB45S3.3-15 S45S5-10 SB45S5-8 SB45S12-4.2 SB45S15-3		89 88 89 89 87 89 89		%

Parameter	Conditions	Models	Min	Typ.	Max	Unit
Load Change 50%-75% or 25% to 50% of I _{out} Max, di/dt = 0.1 A/μs	Co = 1 μF ceramic and 10 μF tantalum	All		100	150	mV
Settling Time to 1% of V _{out}		All		80		μs
Load Change 50%-75% or 25% to 50% of I _{out} Max, di/dt = 1.0 A/μs	Co = 1 μF ceramic and 330 μF Tantalum	All		100	150	mV
Settling Time to 1% of V _{out}		All		80		μs
Isolation Capacitance				1000		pF
Isolation Resistance			10			MΩ
Isolation Voltage – Input to Output		All Standard models	2250			VDC
Isolation Voltage – Input to Output		All I Option model	2828			VDC

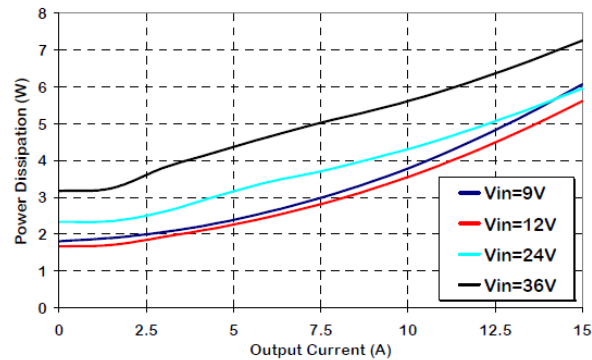
RELIABILITY				
Per Telcordia SR-332, Issue 2: Method I, Case 3 (I _Q =80% of I _{Q_max} , T _A =40°C, airflow = 200 lfm, 90% confidence)	MTFB	SB22S3.3-15	3,078,786	Hours
		SB22S5-8	3,237,656	
		SB45S3.3-15	3,172,083	
		S45S5-10	3,235,056	
		SB45S5-8	3,499,841	
		SB45S12-4.2	4,086,852	
		SB45S15-3	3,563,961	
	FITs (failures in 10 ⁹ hours)	SB22S3.3-15	325	/10 ⁹ Hours
		SB22S5-8	309	
		SB45S3.3-15	315	
		S45S5-10	309	
		SB45S5-8	286	
		SB45S12-4.2	245	
		SB45S15-3	281	

Notes: 1) The combination of trim and remote sense cannot exceed 10% of V_{OUT-Nom}

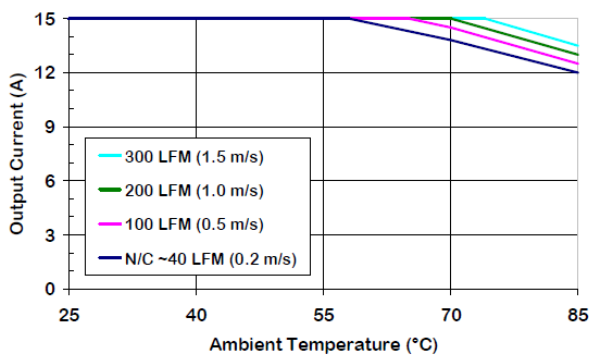
Efficiency vs. Load Curves



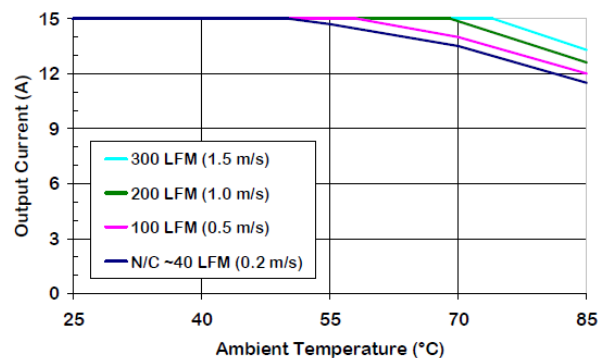
SB22S3.3-15 Efficiency vs Output Current, 300lfm airflow, 25°C ambient.



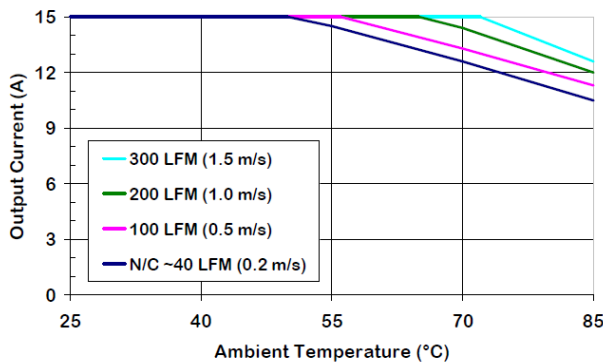
SB22S3.3-15 Power Dissipation vs. Load Current, 300lfm airflow, 25°C ambient.



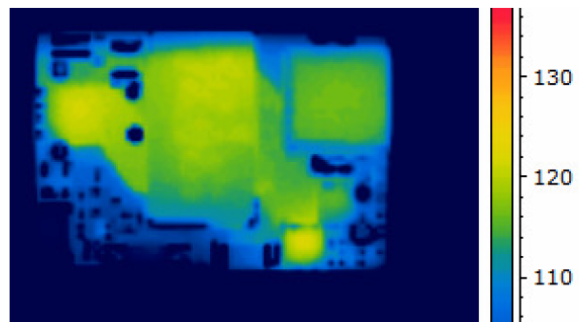
SB22S3.3-15 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 18 V.)



SB22S3.3-15 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 12 V.)

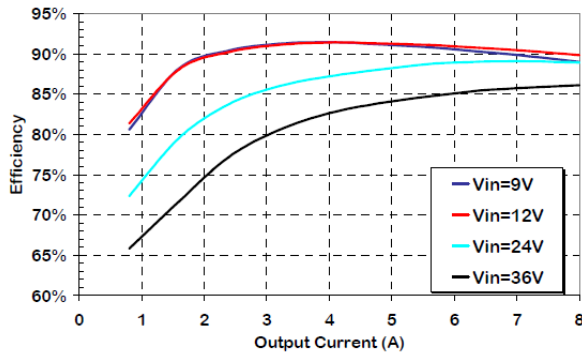


SB22S3.3-15 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 24 V)

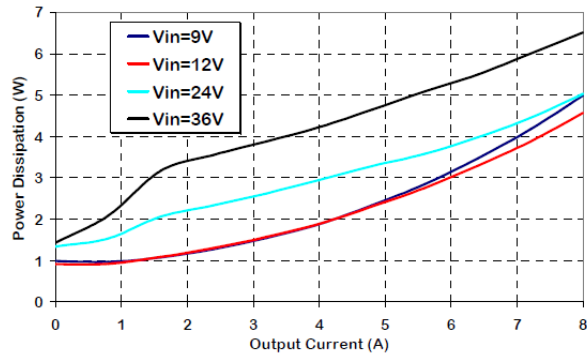


SB22S3.3-15 Thermal Image of 15A output, 70C Ambient, 200lfm airflow, Vin = 18V, airflow from pin 3 to pin 1, T_{max} = 122°C

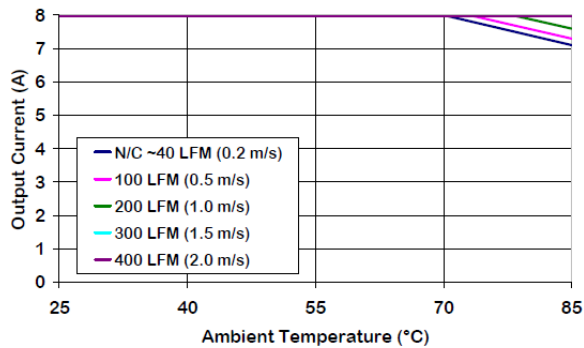
Efficiency vs. Load Curves



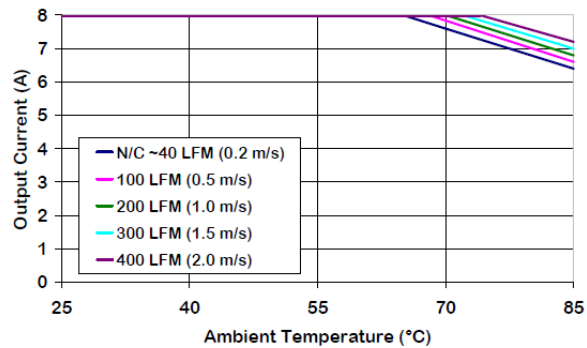
SB22S5-8 Efficiency vs Output Current, 300lfm airflow, 25°C ambient.



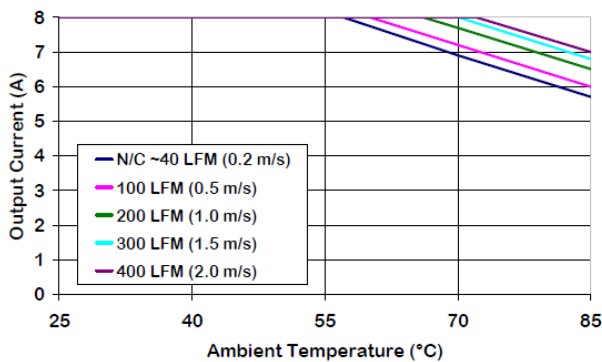
SB22S5-8 Power Dissipation vs. Load Current, 300lfm airflow, 25°C ambient.



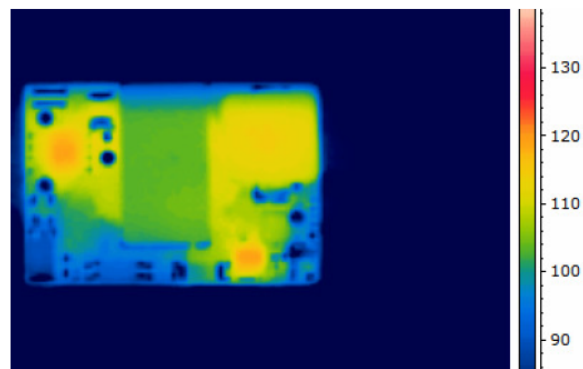
SB22S5-8 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 18 V.)



SB22S5-8 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 12 V.)

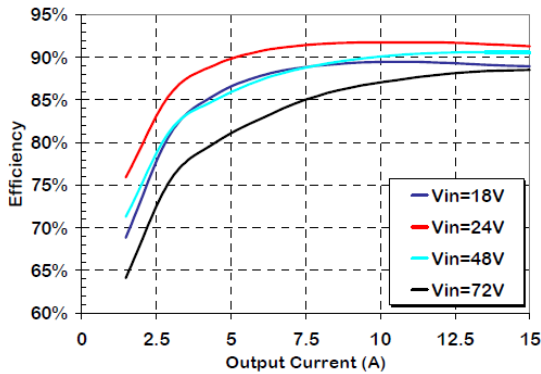


SB22S5-8 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 24 V.)

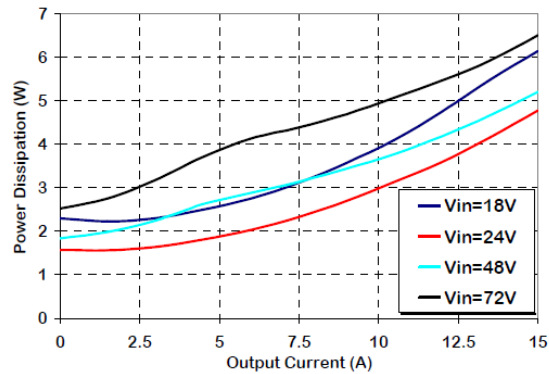


SB22S5-8 Thermal Image 8A output, 70C Ambient, 200lfm airflow, Vin = 18V, airflow from pin 3 to pin 1, T_{max} = 117°C

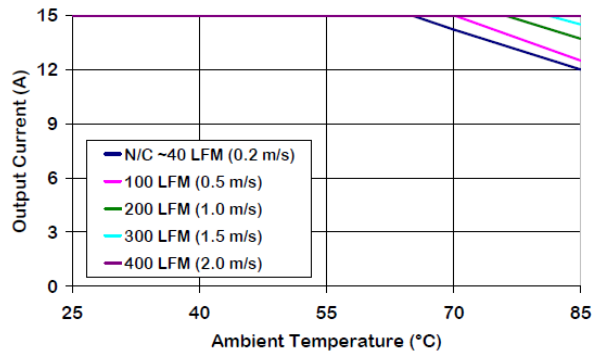
Efficiency vs. Load Curves



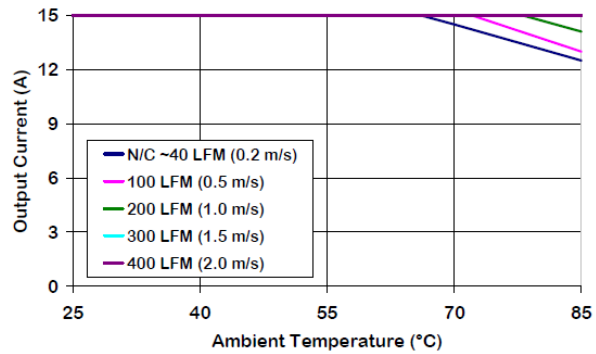
SB45S3.3-15 Efficiency vs Output Current, 300lfm airflow, 25°C ambient.



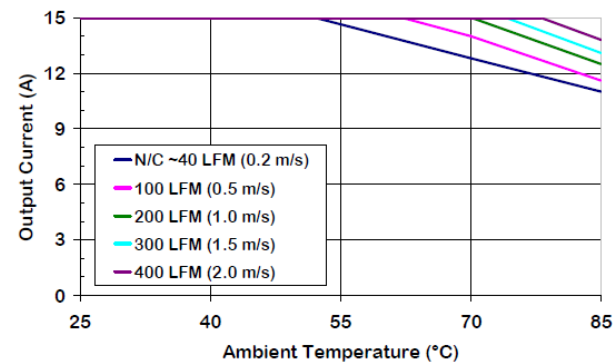
SB45S3.3-15 Power Dissipation vs. Load Current, 300lfm airflow, 25°C ambient.



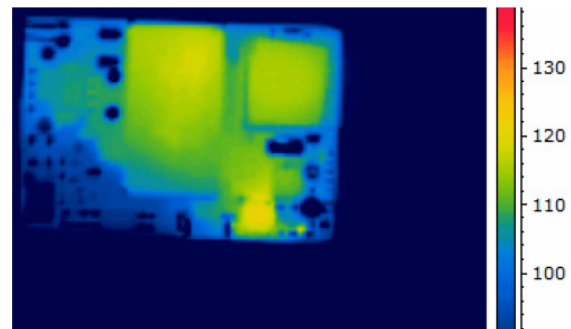
SB45S3.3-15 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 36 V)



SB45S3.3-15 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 24 V)

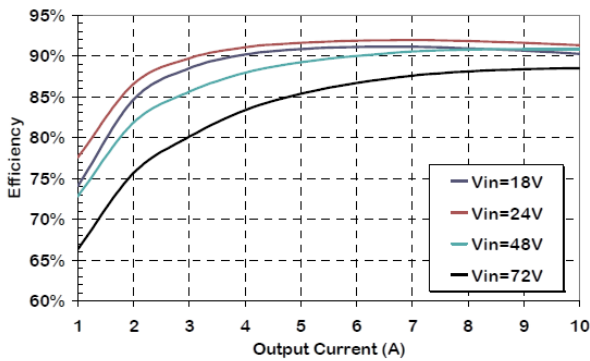


SB45S3.3-15 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 48 V)

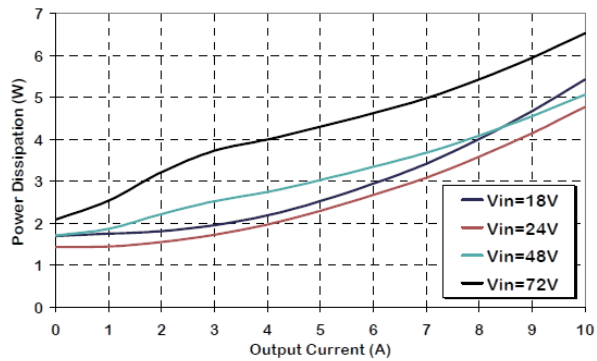


SB45S3.3-15 Thermal Image, 15A output, 70C Ambient, 200lfm airflow, Vin = 48V, airflow from pin 3 to pin 1, Tmax = 122°C

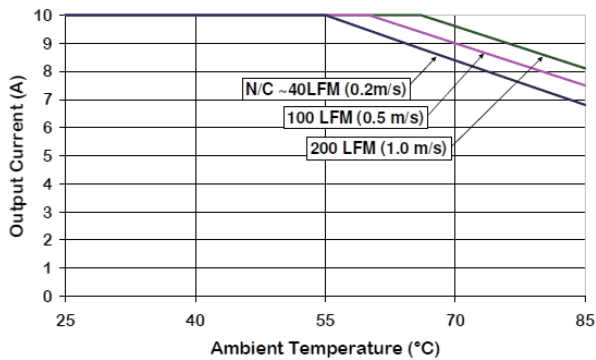
Efficiency vs. Load Curves



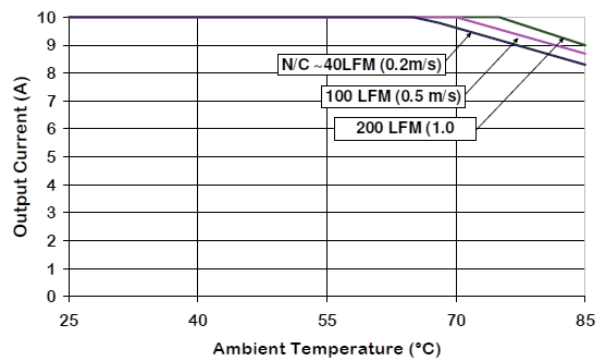
SB45S5-10 Efficiency vs. Output Current,
300lfm airflow, 25°C ambient.



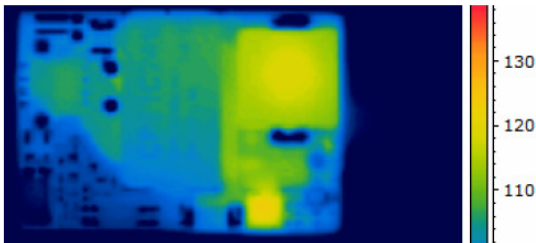
SB45S5-10 Power Dissipation vs. Load
Current, 300lfm airflow, 25°C ambient.



SB45S5-10 Output Current Derating vs Ambient
Temperature & Airflow (converter mounted vertically
with air flowing from pin 3 to pin 1, Vin = 48 Volts

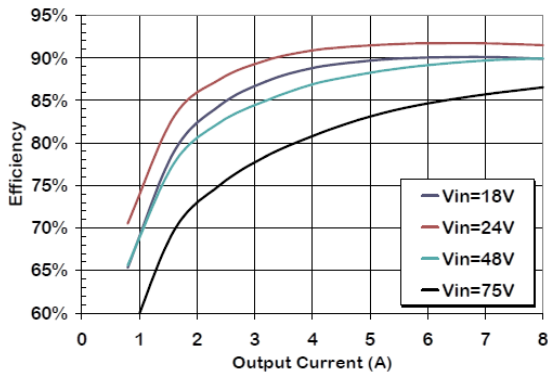


SB45S5-10 Output Current Derating vs Ambient
Temperature & Airflow (converter mounted vertically
with air flowing from pin 3 to pin 1, Vin = 24 Volts

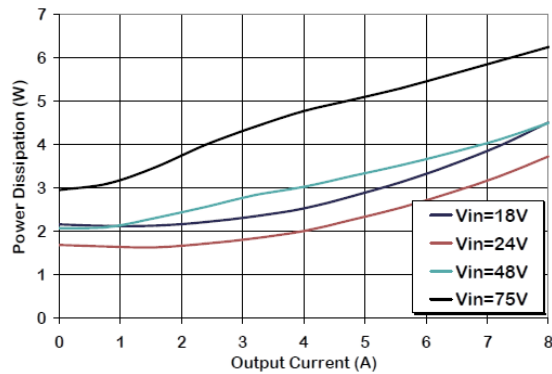


SB45S5-10 Thermal Image, 10A output, 55C
Ambient, 100 LFM airflow, Vin = 48V, airflow from
pin 3 to pin 1, $T_{max} = 120^{\circ}\text{C}$

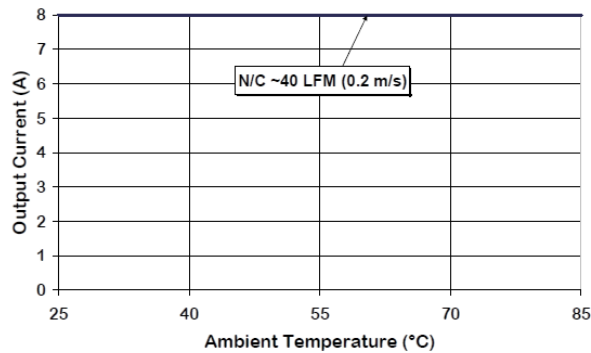
Efficiency vs. Load Curves



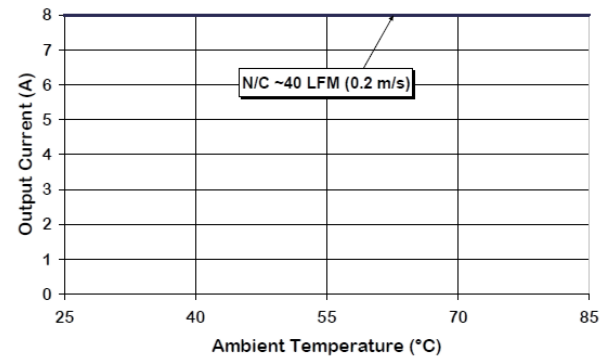
SB45S5-8 Efficiency vs Output Current, 300lfm airflow, 25°C ambient.



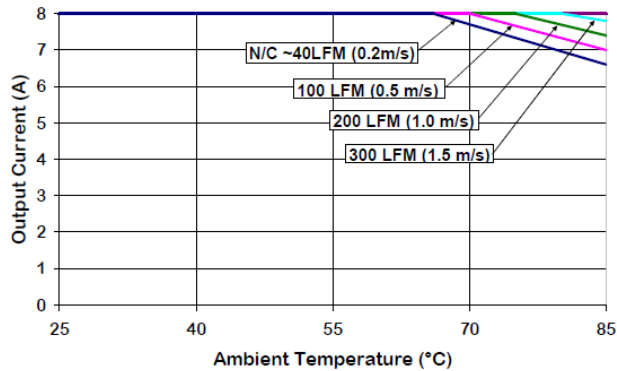
SB45S5-8 Power Dissipation vs. Load Current, 300lfm airflow, 25°C ambient.



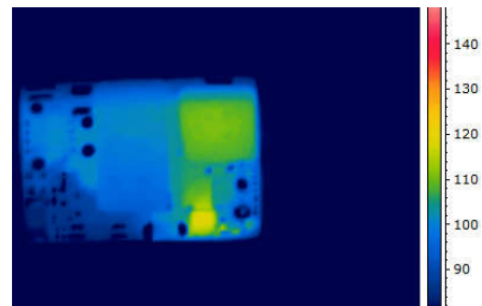
SB45S5-8 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 36 V)



SB45S5-8 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 24 V.)

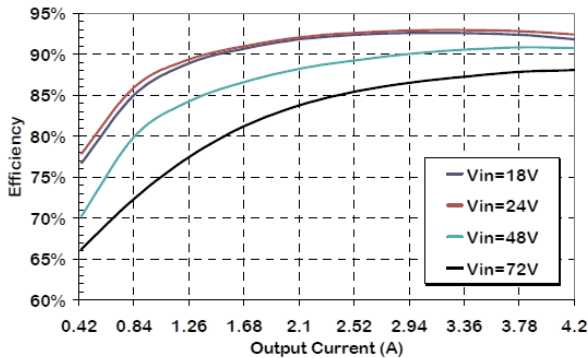


SB45S5-8 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 48 V)

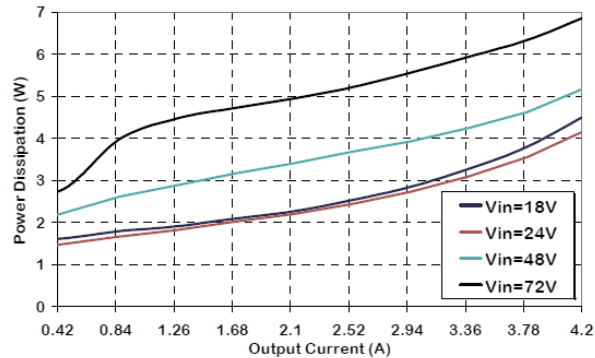


SB45S5-8 Thermal Image (8A output, 70C Ambient, 200lfm airflow, Vin = 48V, airflow from pin 3 to pin 1, T_{max} = 118°C)

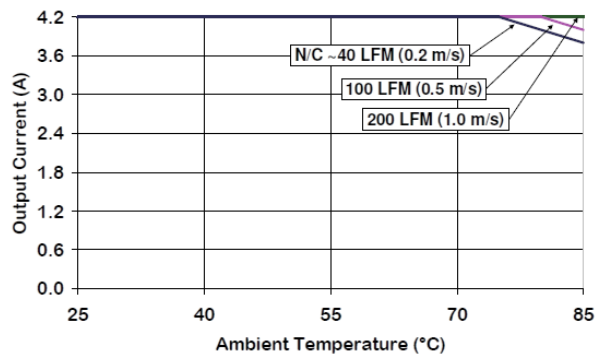
Efficiency vs. Load Curves



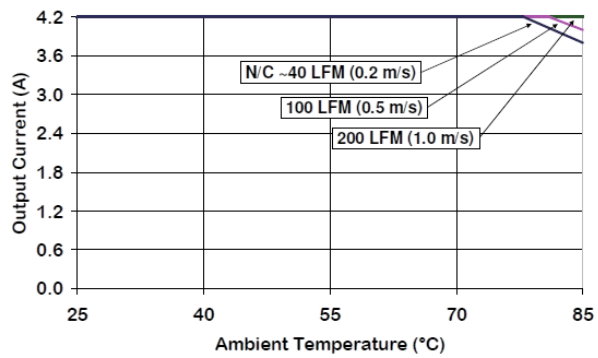
SB45S12-4.2 Efficiency vs Output Current, 300lfm airflow, 25°C ambient.



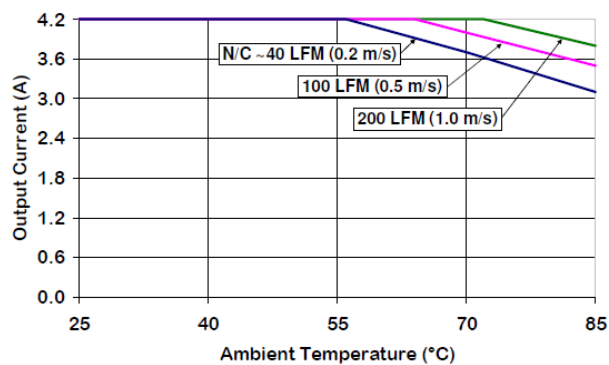
SB45S12-4.2 Power Dissipation vs. Load Current, 300lfm airflow, 25°C ambient.



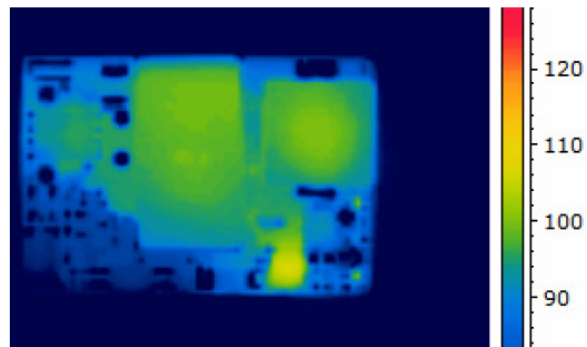
SB45S12-4.2 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 24 V)



SB45S12-4.2 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 36 V)

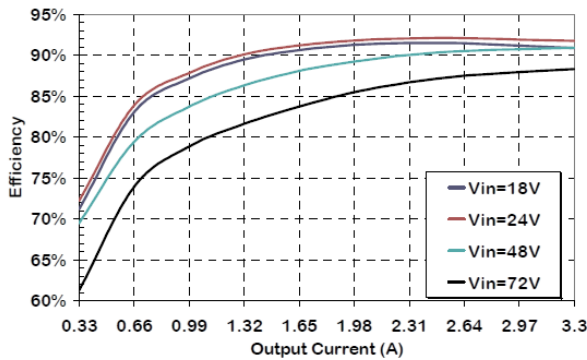


SB45S12-4.2 Output Current Derating vs Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 48 V)

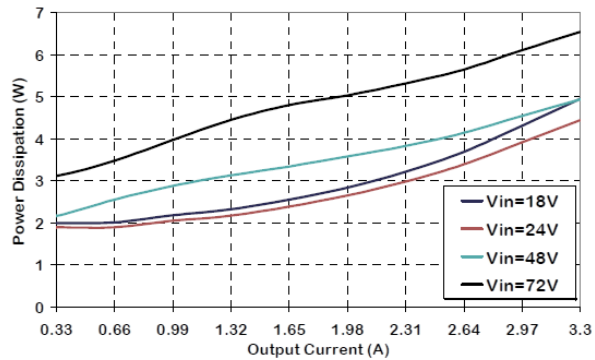


SB45S12-4.2 Thermal Image, 4.2A output, 55C Ambient, 200lfm airflow, Vin = 48V, airflow from pin 3 to pin 1, T_{max} = 106°C

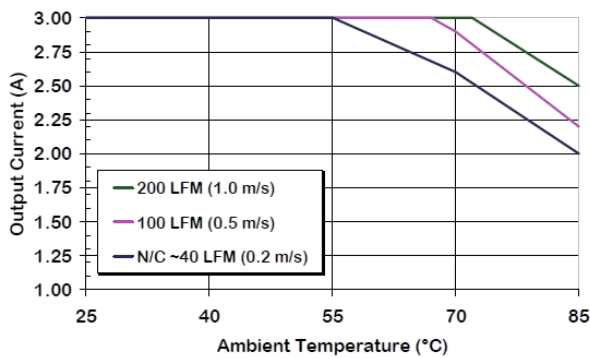
Efficiency vs. Load Curves



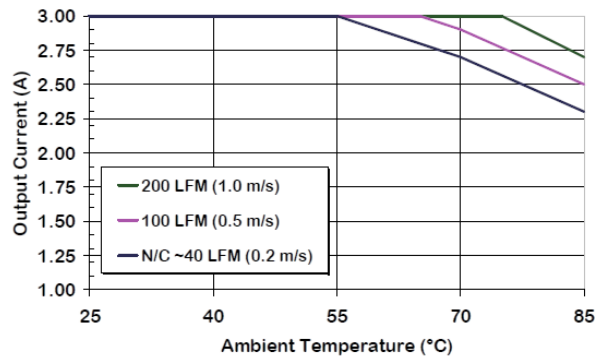
SB45S15-3 Efficiency vs. Output Current, 300lfm airflow, 25°C ambient.



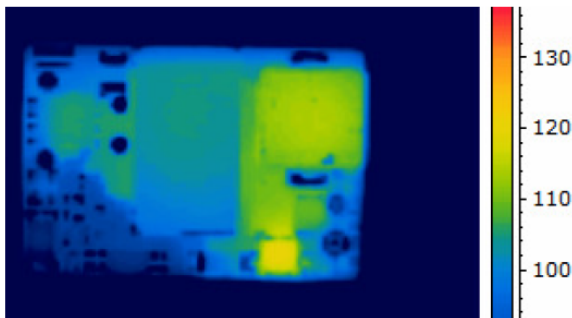
SB45S15-3 Power Dissipation vs. Load Current, 300lfm airflow, 25°C ambient.



SB45S15-3 Output Current Derating vs. Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 48 Volts)

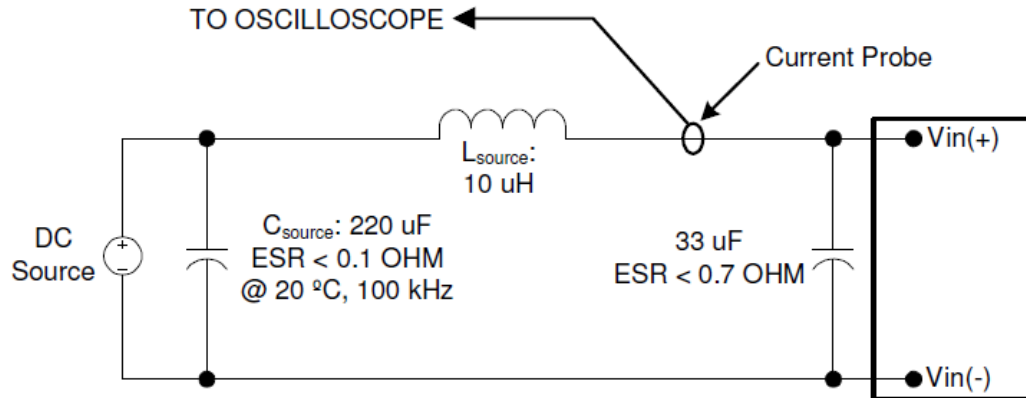


SB45S15-3 Output Current Derating vs. Ambient Temperature & Airflow (converter mounted vertically with air flowing from pin 3 to pin 1, Vin = 24 Volts)



SB45S15-3 Thermal Image, 3A output, 70C Ambient, 200 LFM airflow, Vin = 48V, airflow from pin 3 to pin 1, T_{max} = 121°C)

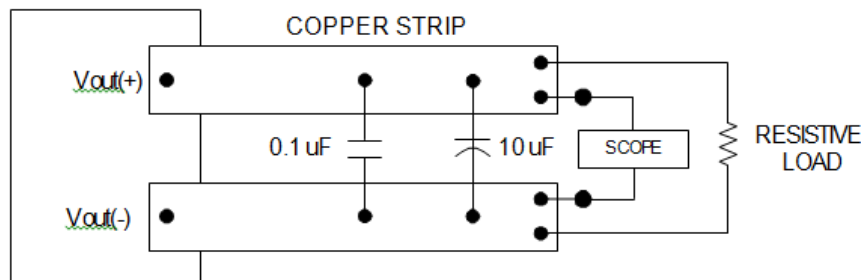
INPUT REFLECTED RIPPLE TEST SETUP:



Note: Measure input reflected-ripple current with a simulated source inductance (L_{test}) of 10 uH. Capacitor CS offsets possible source impedance.

Input Reflected-ripple Current Test Setup.

OUTPUT RIPPLE TEST SETUP:



Note: Use a 0.1 μF X7R ceramic capacitor and a 10 μF @ 25V tantalum capacitor. Scope measurement should be made using a BNC socket. Position the load 3 in. [76mm] from module.

Peak-to-Peak Output Noise Measurement Test Setup.

OUTPUT VOLTAGE TRIM

Output voltage adjustment is accomplished by connecting an external resistor between the Trim Pin and either the +Sense or –Sense pins.

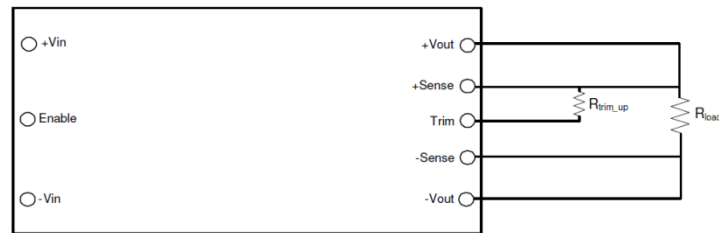
▪ TRIM UP EQUATION:

Where R_{trim_up} is the resistance value in k-ohms and $\Delta\%$ is the percent change in the output voltage. E.g. to trim the output up 10%,

$$R_{trim_up} = \left[\frac{5.1 \times V_{o_nom} \times (100 + \Delta\%)}{1.225 \times \Delta\%} - \frac{510}{\Delta\%} - 10.2 \right] \times k\Omega$$

$$R_{trim_up} = \left[\frac{5.1 \times 15 \times (100 + 10)}{1.225 \times 10} - \frac{510}{10} - 10.2 \right] \times k\Omega$$

or $R_{trim_up} = 626\text{ k}\Omega$.

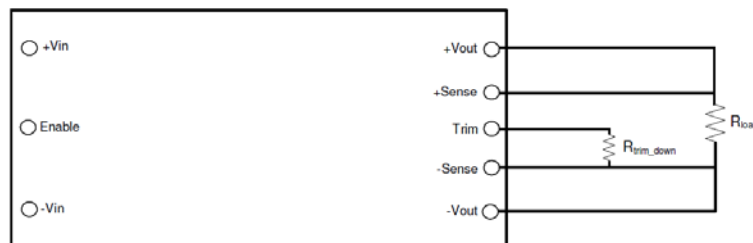


Trim UP circuit configuration

▪ **TRIM DOWN EQUATION:**

$$R_{trim_down} = \left(\frac{510}{\Delta\%} - 10.2 \right) \times \text{k}\Omega$$

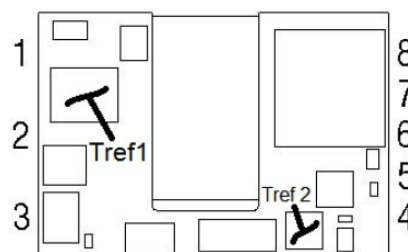
Where R_{trim_down} is the resistance value in k ohms and $\Delta\%$ is the percent change in the output voltage.



Trim DOWN circuit configuration

THERMAL DERATING

- It is preferable that the DC-DC module has an unobstructed flow of air across the unit for best thermal performance. Components taller than ~ 2mm in front of the module can deflect airflow and possibly create hotspots.
- Significant cooling is achieved through conductive flow from the modules I/O pins to the host PCB. Sufficiently large traces connecting the dc-dc converter to the source and load will help ensure thermal derating performance will meet or exceed the derating curves published in this datasheet. Thermal reliefs are not recommended on power pin connections.
- If the module is expected to be operated near the load limits defined in the derating curves, insystem verification of module derating performance should be performed to ensure long-term system reliability. Peak temperatures are to be measured using infrared thermography or by gluing a fine gauge (AWG #40) thermocouple at the Tref location(s) shown below. Tref1 should be monitored for input voltages below 36 Vin, Tref2 for input voltages > 36 Vin. Temperatures at the specified location(s) should not to exceed 123°C in order to maintain maximum converter reliability.



INPUT UNDERVOLTAGE LOCKOUT

- The converter is disabled until the input voltage has exceeded the UVLO turn-on threshold. Once the input voltage exceeds this level (see Input Under-Voltage Lock-out in Electrical Specifications table) the module will commence soft-start. Hysteresis of 2-3 volts minimizes the likelihood of pulling the input voltage below the turn-off threshold during startup which could create an undesirable on/off cycling condition. Once started, the converter will continue to operate until the input voltage subsequently falls below the UVLO turn-off threshold.

ENABLE PIN FUNCTION

- The module has a remote enable function that allows it to be turned on or off remotely. The Enable pin is referenced to the negative input pin (-Vin) of the converter. Modules can be ordered with either negative or positive enable.
- With the negative enable option, the converter will not turn on unless the enable pin is connected to -Vin. The positive enable option allows the converter to turn on as soon as voltage sufficient to exceed the UVLO threshold of the converter has been applied to the input terminals. In this case the module is turned off by connecting the Enable pin to -Vin. On/off thresholds are shown in the Electrical Specifications table.

OUTPUT OVERVOLTAGE PROTECTION

- The module has an independent feedback loop that will disable the output of the converter if a voltage greater than about 125% of the nominal set point is detected. When this threshold is reached, the converter will shut down and remain off for the amount of time specified by the Auto-Restart Period. The converter will attempt a restart once this period of time has elapsed.

OUTPUT OVER-TEMPERATURE PROTECTION

- To provide protection under certain fault conditions, the unit is equipped with a thermal shutdown circuit. The unit will shut-down if the average PCB temperature exceeds approx. 135°C. Keep in mind that thermal shutdown is not intended as a guarantee that the unit will survive temperatures beyond its rating. The module will automatically restart once it has cooled below the shutdown temperature minus hysteresis (typically 20°C.)

SMT VERSION LAYOUT CONSIDERATIONS (IF APPLICABLE)

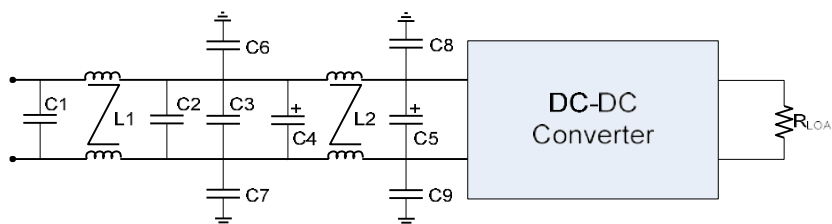
- Copper traces with sufficient cross-section must be provided for all output & input pins. SMT pads tied to internal power/ground planes must have multiple vias around each SMT pad to couple expected current loads from module pins into internal traces/planes. One 0.024" (0.6mm) diameter via for each 4A of expected source or load current must be provided as close to the termination as possible, preferably in the direction of current flow from SMT pad to load. Vias must be at least 0.024" (0.6 mm) away from the SMT pad to prevent solder from flowing into the vias.
- SMT pads on the host card are to be 0.110" (2.79mm) diameter. Solder paste screen opening should be 0.105" diameter and the screen should be 0.006" (0.15 mm) thick (other thicknesses are possible; 0.006" provides a good compromise between solder volume and co-planarity compensation.)

PARALLELING CONVERTERS

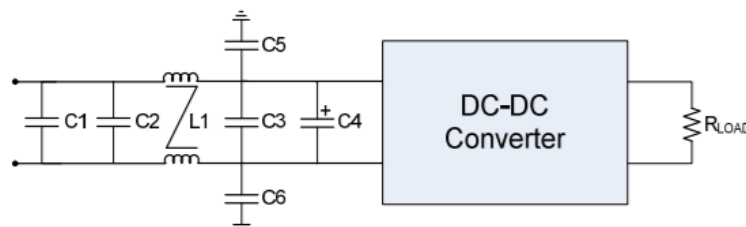
- Modules may be paralleled but it is recommended that the total power draw not exceed the output power rating of a single module. External sharing controllers are recommended for reliability and to ensure equal distribution of the load to the converters. In lower current applications, ORing diodes can be used to prevent converter interactions and improve current sharing.

EMC COMPLIANCE:

To meet Class B compliance for EN55022 (CISPR 22) or FCC part 15 sub part j, the following input filter is required:



EMI Filter for SB22S3.3-15 and SB22S5-8

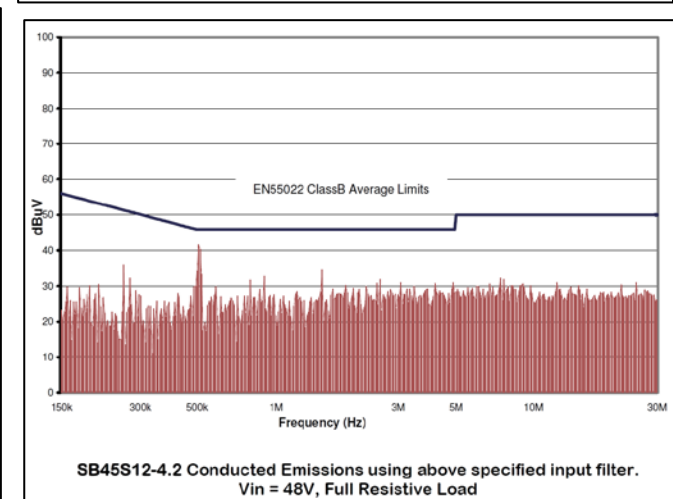
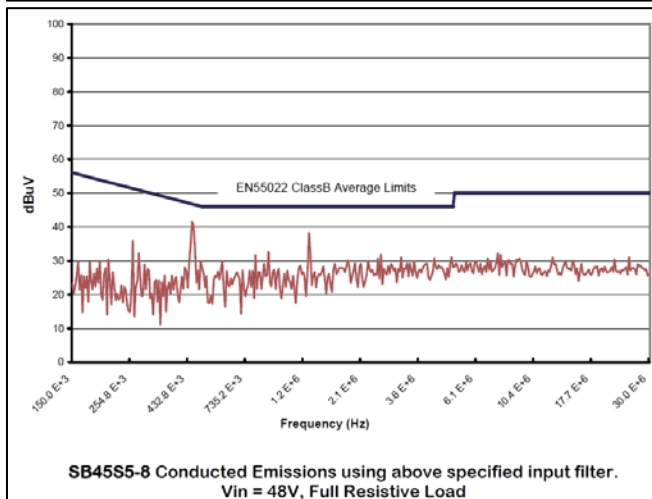
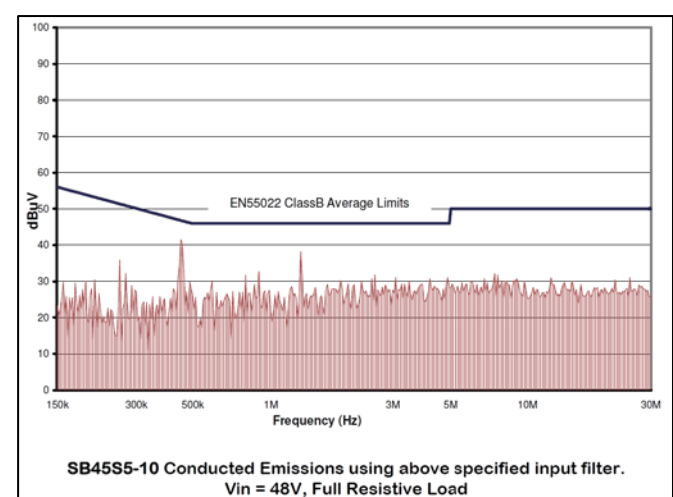
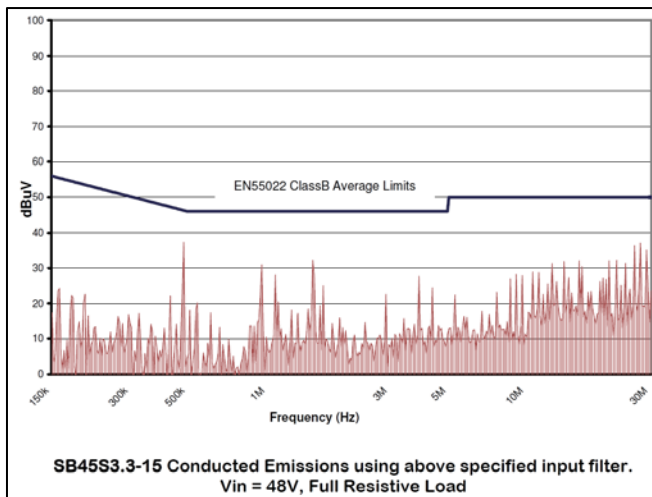
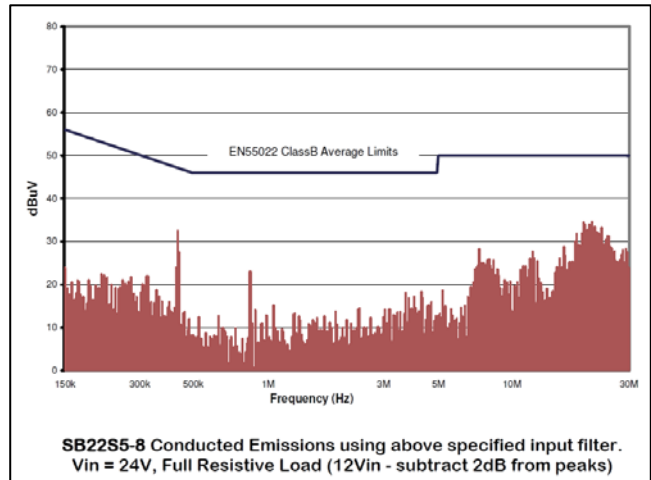
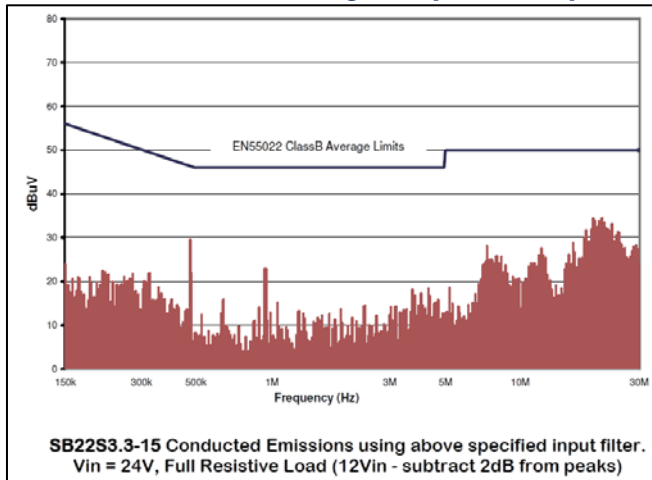


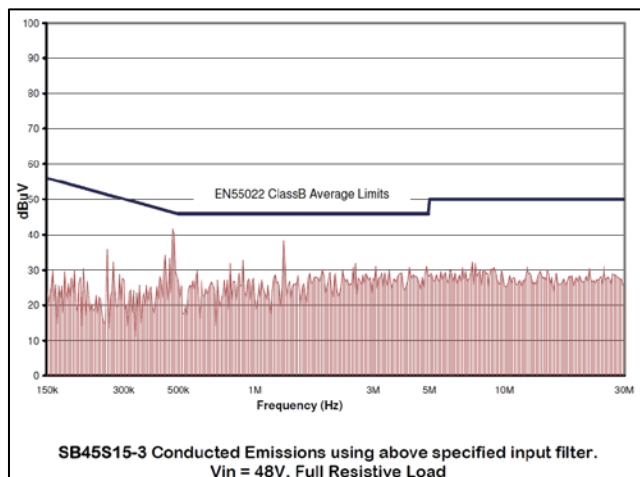
EMI Filter for Others

Model No.	C1, C2, C3	C4	C5	C6	C7, C8, C9	L1	L2
SB22S3.3-15	4.7 μ F Ceramic	Not Used	100 μ F Electrolytic	8.2 nF	8.2 nF	0.59mH	0.59mH
SB22S5-8	4.7 μ F Ceramic	Not Used	100 μ F Electrolytic	8.2 nF	8.2 nF	0.59mH	0.59mH
SB45S3.3-15	2.2 μ F Ceramic	100 μ F Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used
SB45S5-10	2.2 μ F Ceramic	100 μ F Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used
SB45S5-8*	2.2 μ F Ceramic (C2 Not Used)	100 μ F Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used
SB45S12-4.2	2.2 μ F Ceramic	100 μ F Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used
SB45S15-3	2.2 μ F Ceramic	100 μ F Electrolytic	10 nF	10 nF	Not Used	1.32mH	Not Used

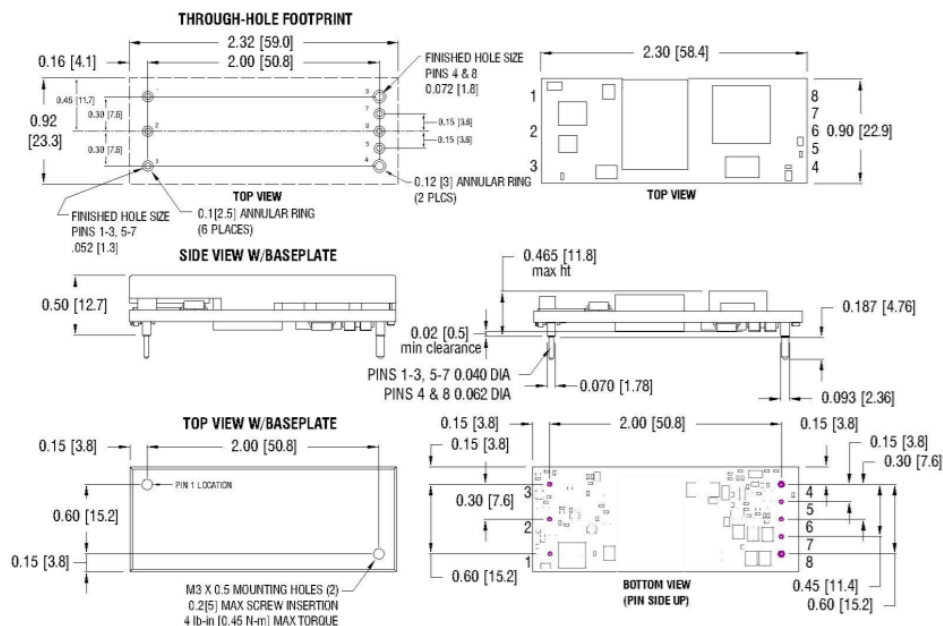
*C2 is not used

Conducted Emissions using the specified input filter





MECHANICAL SPECIFICATIONS

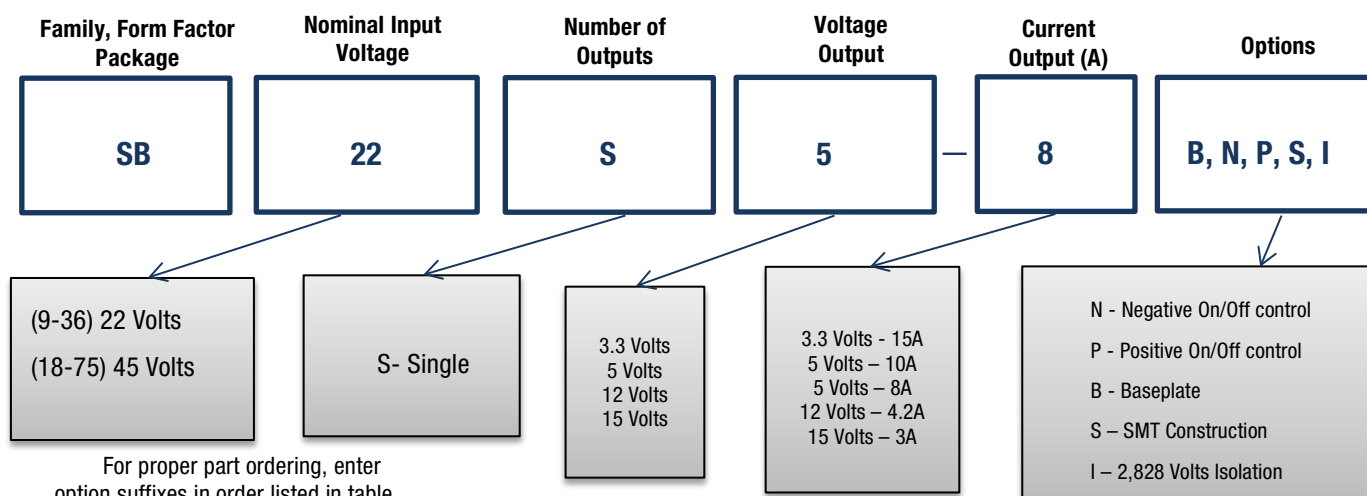


Note: All dimensions are in inches (millimeters). Tolerance: x.xx ± 0.02 in. (0.5mm), x.xxx ± 0.010 in. (0.25 mm) unless otherwise noted

PIN CONNECTIONS

PIN #	DESIGNATION	NOTES
1	V _{IN} (+)	1) All dimensions in inches [mm] Tolerances: .xx ± 0.02 [.x ± .5] .xxx ± 0.010 [.xx ± .25] 2) Input, on/off control and sense/trim pins are Ø 0.040" [1.02] ± 0.002" [0.05] with Ø 0.070" [1.77] standoff shoulders. 3) Output pins 4 & 8 are Ø 0.062" [1.57] ± 0.003" [0.08] with Ø 0.093" [2.36] standoff shoulders 4) All pins are gold plated with nickel under plating. 5) Weight: 12.8 g (0.45 oz.) 6) Workmanship: Meets or exceeds IPC-A-610 Class II
2	On/Off	
3	V _{IN} (-)	
4	V _{OUT} (-)	
5	Sense (-)	
6	Trim	
7	Sense (+)	
8	V _{OUT} (+)	

PART NUMBER ORDERING INFORMATION



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